Silicon Epitaxial Planar Switching Diode

Features

- · Fast switching diode
- Ultra small surface mount package





SOT-323 Plastic Package

Marking Code: PH

Absolute Maximum Ratings (T. = 25 °C)

Parameter		Symbol	Value	Unit	
Non-Repetitive Peak Reverse Voltage		V_{RM}	100	V	
Reverse Voltage		V_R	75	V	
Continuous Forward Current	Single diode loaded Double diode loaded	I _F	175 100	mA	
Repetitive Peak Forward Current		I _{FRM}	500	mA	
Non-repetitive Peak Forward Surge Cur	rrent at t = 1 s at t = 1 ms at t = 1 µs	I _{FSM}	0.5 1 4	А	
Power Dissipation		P_{tot}	200	mW	
Junction Temperature		T _j	150	°C	
Storage Temperature Range		T _{stg}	- 65 to + 150	°C	

Characteristics at T_a = 25 °C

Parameter	Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at I _R = 100 μA	$V_{BR(R)}$	75	-	V
Forward Voltage at $I_F = 1$ mA at $I_F = 10$ mA at $I_F = 50$ mA at $I_F = 150$ mA	V _F	- - -	0.715 0.855 1 1.25	V
Reverse Leakage Current at V_R = 25 V at V_R = 75 V at V_R = 25 V, T_J = 150 °C at V_R = 75 V, T_J = 150 °C	I _R	- - -	30 2.5 60 100	nA µA µA µA
Diode Capacitance at V _R = 0 V, f = 1 MHz	C _{tot}	-	2	pF
Reverse Recovery Time at I_F = 10 mA to I_R = 10 mA, I_{rr} = 0.1 I_R , R_L = 100 Ω	t _{rr}	-	4	ns



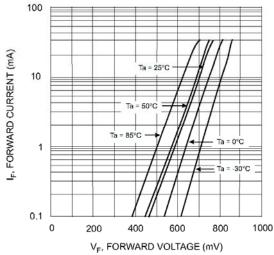








Dated: 26/09/2009



10.0

Ta = 100°C

Ta = 75°C

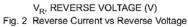
Ta = 25°C

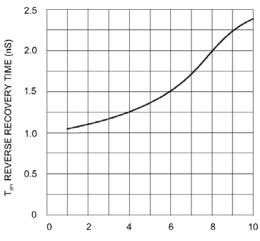
Ta = 25°C

Ta = 30°C

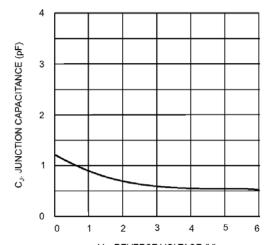
Fig 2 B

Fig. 1 Forward Current vs. Forward Voltage





I_F, FORWARD CURRENT (mA) Fig. 3. Reverse Recovery Time vs. Forward Current



V_R, REVERSE VOLTAGE (V)
Fig. 4. Typical Junction Capacitance vs.
Reverse Voltage





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